

| | Type | L # | Hits | Search Text | DBs | Time Stamp |
|---|------|-----|-----------|---|---|-------------------------|
| 1 | BRS | L1 | 907 23 | semiconductor and (recess or groove or trench) | USP AT; US- PGP UB; EPO ; JPO ; DER WEN T; IBM TDB | 2001/0 9/07 17:22 |

| | Comments | Error Definition | Errors |
|---|----------|------------------|--------|
| 1 | | | 0 |

| | Type | L # | Hits | Search Text | DBs | Time Stamp |
|---|------|-----|----------|--------------------------|---|-------------------------|
| 2 | BRS | L2 | 552 3 | 1 and well and buried | USP AT; US- PGP UB; EPO ; JPO ; DER WEN T; IBM TDB | 2001/0 9/07 17:23 |

| | Comments | Error Definition | Errors |
|---|----------|------------------|--------|
| 2 | | | 0 |

| | Type | L # | Hits | Search Text | DBs | Time Stamp |
|---|------|-----|------|-----------------------------|---|-------------------------|
| 3 | BRS | L3 | 778 | 2 and memory and peripheral | USP AT; US- PGP UB; EPO ; JPO ; DER WEN T; IBM TDB | 2001/0 9/07 17:23 |

| | Comments | Error Definition | Errors |
|---|----------|------------------|--------|
| 3 | | | 0 |